2SD1205, 2SD1205A

Silicon NPN epitaxial planar type darlington

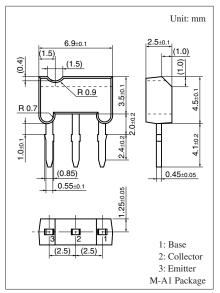
For low-frequency amplification

■ Features

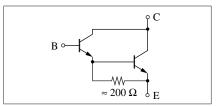
- Forward current transfer ratio h_{FE} is designed high, which is appropriate to the driver circuit of motors and printer hammer: $h_{FE} = 4\,000$ to 20 000.
- A shunt resistor is omitted from the driver.
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1205	V _{CBO}	30	V
(Emitter open)	2SD1205A		60	
Collector-emitter voltage	2SD1205	V _{CEO}	25	V
(Base open)	2SD1205A		50	
Emitter-base voltage (Coll	V_{EBO}	5	V	
Collector current	I_C	500	mA	
Peak collector current	I_{CP}	750	mA	
Collector power dissipation	P _C	400	mW	
Junction temperature	T _j	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



Internal Connection



■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

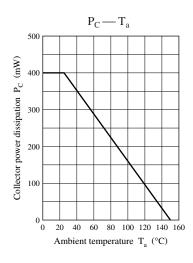
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage	2SD1205	V_{CBO}	$I_C = 100 \ \mu A, I_E = 0$	30			V
(Emitter open)	2SD1205A			60			
Collector-emitter voltage	2SD1205	V_{CEO}	$I_C = 1 \text{ mA}, I_B = 0$	25			V
(Base open)	2SD1205A			50			
Emitter-base voltage (Collector open)		V_{EBO}	$I_E = 100 \ \mu A, I_C = 0$	5			V
Collector-base cutoff current (Emitter open)		I_{CBO}	$V_{CB} = 25 \text{ V}, I_E = 0$			100	nA
Emitter-base cutoff current (Collector open)		I_{EBO}	$V_{EB} = 4 \text{ V}, I_C = 0$			100	nA
Forward current transfer ratio *1, 2		h_{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 500 \text{ mA}$	4000		20 000	_
Collector-emitter saturation	voltage *1	V _{CE(sat)}	$I_C = 500 \text{ mA}, I_B = 0.5 \text{ mA}$			2.5	V
Base-emitter saturation voltage *1		V _{BE(sat)}	$I_C = 500 \text{ mA}, I_B = 0.5 \text{ mA}$			3	V
Transition frequency		f_T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

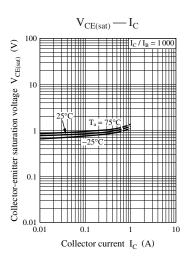
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

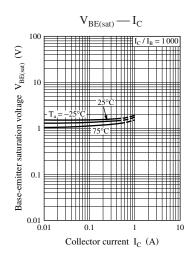
^{*2:} Rank classification

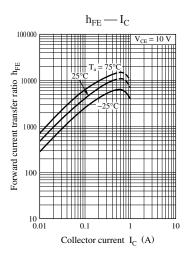
Rank	Q	R		
h_{FE}	4000 to 10000	8 000 to 20 000		

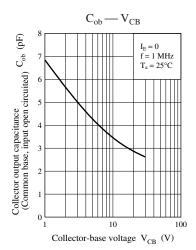
^{2. *1:} Pulse measurement











2 SJC00211BED

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